ThinkStation P330 Tower Gen 2 30CY007RUS

Product

ThinkStation P330 Tower Gen 2

Region

NA

Country/Region

USA

Machine Type

30CY

TopSeller

TopSeller

Processor

Intel Xeon E-2224 4C/4T/3.4GHz/8MB/71W/DDR4-2666

Integrated Graphics

None

Discrete Graphics

NVIDIA Quadro RTX 4000 8GB

Chipset

Intel C246

HDD Controller

Onboard Intel RSTe SATA RAID

M.2 SSD RAID Controller

Onboard Intel RSTe PCIe

Memory

1x 16GB UDIMM DDR4-2666 ECC

Internal Disk Drive

None

M.2 SSD Drive

1x 512GB SSD M.2 PCIe NVMe Opal

Optane Memory

None

Optical

1x 9.0mm DVD±RW

Media Reader

SD Reader

Ethernet

1x GbE RJ-45

WLAN + Bluetooth

None

Optional Front Ports

None

Optional Rear Ports

None

Chassis Intrusion Switch

None

Cover Lock

None

Cable Lock

None

Dust Filter

None

Kevboard

USB Traditional Keyboard, Black, English

Mouse

USB Calliope Mouse

Power Supply

400W Platinum Fixed

System Management

Intel vPro with AMT 12

Operating System

Windows 10 Pro 64 for Workstations, English

Bundled Software

None

Base Warrantv

3-year, Onsite

Bundled Service

None

EAN/UPC/JAN

194632678819

End of Support

2026-08-24

Announce Date

2019-12-10

Recommended Services

Best

4Y Lenovo Protect (Premier Support + Keep Your Drive + Accidental Damage Protection) (5PS0N73191)

Retter

4Y Lenovo Support (Premier Support + Keep Your Drive) (5PS0N73243)

Good

3Y Premier Support Upgrade from 3Y Onsite (5WS0U26646)

Notes:

California Electronic Waste Recycling Fee

In California, per state law, Lenovo charges an electronic waste recycling fee on this covered device at the time of sale of the product. For more information, go to: https://www.calrecycle.ca.gov/Electronics/Consumer

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ThinkStation P330 Tower Gen 2 (30CY and 30D0) Platform Specifications - I of II

Components	Specification	Components	Specification
Form factor	18L Tower		Up to two PCle 3.0 x16 slots for discrete graphics card (Slot 1 and 3).
Dimensions	Height: 376 mm (14.8 in). Width: 165 mm (6.5 in). Depth: 328 mm (12.9 in)	1	Supports the following graphics adapters:
Weight	Maximum configuration: 23.37 lb (10.6kg)	1	Graphics Memory Power Connector Max Qty
	Supports one of the following processors:	Discrete Graphics Offering	Quadro P400 2GB wGDDR5 30W 3x miniDP 2
	Xeon E-2286G 6C/12T/4.0GHz/12MB/95W/DDR4-2666 400W PSU needed		Quadro P620 2GB GDDR5 40W 4x miniDP 2
	Xeon E-2278G 8C/16T/3.4GHz/16MB/80W/DDR4-2666 400W PSU needed		Quadro P1000 4GB GDDR5 50W 4x miniDP 2 Quadro P2000 5CR CDDR5 75W 4x DR 2
	Xeon E-2276G 6C/12T/3.8GHz/12MB/80W/DDR4-2666		Quadro P2000 5GB GDDR5 75W 4x DP 2 Quadro P2200 5GB GDDR5X 75W 4x DP 2
	Xeon E-2274G 4C/8T/4.0GHz/8MB/83W/DDR4-2666		Quadro P4000 8GB GDDR5 105W 4x DP 1
	Xeon E-2246G 6C/12T/3.6GHz/12MB/80W/DDR4-2666		Quadro P5000 16GB GDDR5X 180W DVI-D DL + 4x DP 1
	Xeon E-2244G 4C/8T/3.8GHz/8MB/71W/DDR4-2666		Ouedre DTV 4000 RCB CDDDs 160M 3x DP,
	Xeon E-2236 6C/12T/3.4GHz/12MB/80W/DDR4-2666		1X VII tualeii ik
	Xeon E-2234 4C/8T/3.6GHz/8MB/71W/DDR4-2666		GeForce GTX 1660 Ti 6GB GDDR6 120W 1x DP, 1x HDMI, 1x DVI-D DL 1
	Xeon E-2226G 6C/6T/3.4GHz/12MB/80W/DDR4-2666		IX DVI-D DL
	Xeon E-2224G 4C/4T/3.5GHz/8MB/71W/DDR4-2666		GeForce RTX 2070 8GB GDDR6 175W 3x DP, 1x HDMI, 1x VirtualLink 1
	Xeon E-2224 4C/4T/3.4GHz/8MB/71W/DDR4-2666 Xeon E-2186G 6C/12T/3.8GHz/12MB/95W/DDR4-2666 400W PSU needed		2v DP 1v HDMI
	Xeon E-2174G 4C/8T/3.8GHz/8MB/71W/DDR4-2666		GeForce RTX 2080 8GB GDDR6 215W 3x DF, 1x HDWII, 1
Drococc	Core i9-9900K 8C/16T/3.6GHz/16MB/95W/DDR4-2666 400W PSU needed		
Processor	Core i9-9900 8C/16T/3.1GHz/16MB/65W/DDR4-2666		Note: 2x Quadro P2000, Quadro P4000, Quadro P5000, Quadro RTX 4000, GeForce cards needs 400W PSU
	Core i7-9700K 8C/8T/3.6GHz/12MB/95W/DDR4-2666 400W PSU needed	Storage Controller	Storage Controller Type Interface Disk Type RAID
	Core i7-9700 8C/8T/3.0GHz/12MB/65W/DDR4-2666		
	Core i7-8700K 6C/12T/3.7GHz/12MB/95W/DDR4-2666		Onboard Intel RST PCIe RAID Std PCIe NVMe M.2 PCIe SSD 0/1
	Core i7-8700 6C/12T/3.2GHz/12MB/65W/DDR4-2666		Disk Type Interface RPM Offering Max Qty
	Core i5-9600K 6C/6T/3.7GHz/9MB/95W/DDR4-2666 400W PSU needed		3.5" SATA HDD SATA 6Gb/s 7.2K 1TB/2TB/4TB 3
	Core i5-9600 6C/6T/3.1GHz/9MB/65W/DDR4-2666 Core i5-9500 6C/6T/3.0GHz/9MB/65W/DDR4-2666	Storage Support	2.5" SATA HDD SATA 6Gb/s 7.2K 500GB FIPS 4
	Core i5-9400F 6C/6T/2.9GHz/9MB/65W/DDR4-2666		2.5" SATA SSD SATA 6Gb/s 256GB/512GB/1TB 4
	Core i5-9400 6C/6T/2.9GHz/9MB/65W/DDR4-2666		Optane Memory PCIe NVMe 32GB 1,
	Core i5-8500 6C/6T/3.0GHz/9MB/65W/DDR4-2666		Optane Memory PCIe NVMe 32GB used with HDD/SSD M.2 PCIe SSD PCIe NVMe 256GB/512GB/1TB 3
	Core i3-9300 4C/4T/3.7GHz/8MB/62W/DDR4-2400		
	Core i3-9100 4C/4T/3.6GHz/6MB/65W/DDR4-2400		Up to five bays with four disk bays plus one slim optical bay, supports up to 3x
	Core i3-8300 4C/4T/3.7GHz/8MB/62W/DDR4-2400		3.5" HDD plus 1x 2.5" SSD, or 4x 2.5" HDD/SSD
	Core i3-8100 4C/4T/3.6GHz/6MB/65W/DDR4-2400	4	Bay 1 Primary disk bay, 3.5" or 2.5"
Chipset	Intel C246 Chipset		Bay 2 2.5" SATA bay, cannot be available when 2nd Quadro P2000 is used
Memory Sockets	4 DIMM sockets with 2 channels	_	Bay 3 Secondary disk bay, 3.5" or 2.5"
Memory Types	8GB/16GB DDR4-2666 UDIMM ECC or	Storage Bays	Bay 4 5.25" Flex bay, supports one of the following:
, ,,	4GB/8GB/16GB/32GB DDR4-2666 UDIMM non-ECC	Storage Days	 Flex module for optional front eSATA/Thunderbolt/IEEE1394
Memory Capacity	64GB with 4 x 16GB for UDIMM ECC or 128GB with 4 x 32GB UDIMM non-ECC ECC on models with UDIMM ECC memeory	-	 3rd disk bay, 3.5" or 2.5", removable, via Front Access Storage
Memory Protection			Enclosure, using SATA 4 connector as eSATA mode
Expansion slots	Three PCIe 3.0 slots as following:		• 3rd disk bay, 3.5" or 2.5", via 5.25" to 3.5" HDD Kit
	Slot 1 PCIe 3.0 x16, full height, half length, links to CPU		Bay 5 9mm Slim ODD bay
	Slot 2 PCle 3.0 x1, full height, full length, links to PCH		M.2 3x M.2 SSD (1 onboard. 2 via PCIe to M.2 adapter)
	Slot 3 PCle 3.0 x16 (negotiable link width x4), full height, half length, links to PCH	Media reader	Optional 7-in-1 card reader on most models
Processor graphics	Integrated Intel UHD Graphics P630 in -G suffix Xeon processors, or Intel UHD	Network interfaces WLAN + Bluetooth	One onboard GbE port via integrated gigabit ethernet Intel i219LM, supports
	Craphica 620 in Cara i7 if i0 as Pantium processors		Wake-on-LAN. Optional PCIe ethernet adapters are available
	Works along with discrete graphics to support multi-display, enables three rear		One dedicated onboard M.2 slot for optional Intel Wireless-AC 9560, 2x2,
	display connectors (2 DP standard, 1 DP or HDMI optional)	VVEAIV + Didetootii	2.4GHz/5GHz (160MHz channels), 802.11ac, Bluetooth 5, up to 1.73Gbps
		C	Power-on and admin password. Trusted Platform Module, TCG 2.0 compliant.
		Security features	Optional chassis intrusion switch, E-lock, cable lock, Kensington lock, and pad lock
			Supports Intel vPro on Xeon and selected Core i7 or i5 models.
		Intel vPro	vPro also requires Wireless-AC 9560 if Wi-Fi is needed
			Intel Active Management Technology 12 on Xeon models,
		Intel AMT	Intel Standard Manageability on other models
		Raco warranti	US models comes with 3-year limited onsite service with 9x5/NBD.
		Base warranty	1 or 3-year limited onsite service with 9x5/NBD in EMEA or other GEOs
		HD Audio	Intol HD Audio interface with Booltok AI C223 Codes

Base warranty HD Audio

Intel HD Audio interface with Realtek ALC233 Codec

ThinkStation P330 Tower Gen 2 (30CY and 30D0) Platform Specifications - II of II

Components	Specification		
Front ports	2x USB 3.1 Gen 1 Type A. 2x USB 3.1 Gen 2 Type A. 1x USB 3.1 Gen 1 Type-C. 1x Mic-in. 1x Combo jack		
Rear ports	2x USB 3.1 Gen 1 Type A. 2x USB 2.0 Type-A. 1x RJ-45. 1x COM. 2x DP. 1x Audio line-out Notes: DP needs Core, Pentium, or -G suffix Xeon processor		
Optional front ports (on flex module)	2x Thunderbolt (USB Type-C), one of two ports supports video-out. 1x eSATA. 1x IEEE1394		
Optional rear ports	Supports the following via cable: 1x COM. 1x Parallel. 2x PS/2. 1x DP or 1x HDMI. 2x USB 2.0 Supports the following via PCle adapter: 4x COM. 2x USB 3.1 Type-C. 2x USB 3.1 Gen 1. 1x Thunderbolt. Notes: DP or HDMI needs Core, Pentium, or -G suffix Xeon processor		
Temperature	Operating: 50 °F to 95 °F (10 °C to 35 °C) Non operating (no package): 14 °F to 140 °F (-10 °C to 60 °C) Non operating (with package): -40 °F to 140 °F (-40 °C to 60 °C)		
Altitude	Operating: -15.2 m (-50 ft) to 3048 m (10 000 ft). Storage: -15.2 m (-50 ft) to 10, 668 m (35 000 ft)		
Humidity	Operating: 30%~90%, non-condensing Storage (with package): 20%~90%, non-condensing		
Environmental certification	RoHS-compliant. GREENGUARD. EPEAT Silver rating and ENERGY STAR 7 qualified		
Power supply	Supports one 250W or 400W power supply, 100V - 240V, 92% PSU. Climate Savers Computing Platinum and 80 PLUS Platinum qualified. 400W PSU supports one 6+2-pin aux power connector.		
ISV certifications	Please visit www.thinkworkstations.com/isv-certifications/		
Note:			

Note:
1. Depending on many factors, actual data transfer speed mentioned on this page may be lower than theoretical speed.
2. Any questions or advice on ThinkStation PSREF, please contact ThinkStation PSREF developer













